

Automated Optical Inspection for SPI & SMT Inspection



MVP Versa, Versa Duo and Versa Pro

The Versa platforms combine 3D technologies and MVP's advanced optic systems to allow user to benefit from the superb detection of complex defects using MVPs proprietary, advanced algorithms. Configured with multiple 3D options and standard metrology capability the Versa series of solutions are ultimately flexible for SPI, Pre-Reflow, Post-Reflow or Post-Wave inspection.

Key Features

- SPI and SMT Inspection
- Versa
 - High Resolution Optics
- Versa Duo
 - High Resolution Optics and Laser Profiler
- Versa Pro
 - Projector Based
- Fast Easy-To-Use
- Measurement Based AOI
- High Throughput with Proven Reliable Hardware
- 01005 Solder Joint Inspection







Versa Series

MVP "AOI Elevated"

| Model | Versa Series | | | | |
|---|--|----------------|---------------|------------------|------|
| Version | Versa | Versa | a Duo | Versa Pro | |
| Performance | | | | | |
| Inspection Capability | Paste, Pre-Reflow, Post-Reflow, Post-Wave, | | | | |
| | Selective Solder, BGA, Metrology based measurement tools | | | | |
| Programming Speed | Standard SPI and AOI programs are generated in 10-30 mins | | | | |
| Motion System X and Y | Precision X/Y stage with 0.5 micron positional resolution | | | | |
| Optical Resolution | Options ² from 5-20um | | | | |
| Optics | | | | | |
| Optics Camera | 25mp or 12mp | | | 9.5mp | |
| Optics Illumination | White or Quad Color | | | Red, Blue, White | |
| 3D Measurement System | | | | | |
| 3D Measuring Principle | 3D Lighting | Laser Profiler | | Quad Moiré | |
| 3D Speed ¹ (CM ² /s) | | 16 | 2.6 | 13.2 | 2 |
| 3D Sensor X-Y Resolution (um) | | 12.5 | 5 | 19.6 | 7.8 |
| 3D Sensor Z Repeatability (um) ⁵ | | 0.5 | 0.4 | 1 | 1 |
| Max Component Clearance (mm) | 35 | | | | |
| Software | | | | | |
| Offline Program Generation | ePro | | | | |
| Program Debug Environment | iPro and Validate | | | | |
| SPC and Reporting | AutoData DPC - Sql based data reporting ELSR - End Lot Summary Reporting Optional: AutoData, line integration to paste systems | | | | |
| | | | | | |
| | | | | | |
| CAD and Gerber Inputs | Standard, Placement, Gerber and ODB++ data import | | | | |
| Defect Review | In-Line or Off-Line defect review using iRepair | | | | |
| Multi-Pass | Programmable heights and lighting per pass | | | | |
| Validate ⁷ | Automated Program Validation | | | | |
| System | | | | | |
| Computer | Xeon Processor - Multi-Threading | | | | |
| | 1TB SSD Hard Drive - 32GB Memory | | | | |
| Operating System | Linux based Multi-Threading CentOS Operating System Full network integration (TCP/IP, NFS Protocol) | | | | |
| Networking | Full net | twork integr | ation (TCP/IF | P, NFS Proto | col) |
| Physical | | /- | | 3 | |
| Inspection Envelope ³ | 508mm (20") x 457mm (18") ³ | | | | |
| Board Thickness ⁴ | 0.254 - 12.5mm (0.015") | | | | |
| Clearance | Top Side to 50.8mm (2") | | | | |
| Conveyor Height | SMEMA | | | | |
| Footprint | 990mm (39") W x 1100mm (43") D x 1580mm (62") H | | | | |
| Conveyor Length | 996mm (39") | | | | |
| Power | 208-240VAC 50/60Hz, 10A (Optional 110V) | | | | |
| Air | 60 PSI, 1CFM | | | | |
| Weight ⁶ | 500 kgs (1100 lbs.) | | | | |
| Compliance | CE - (UL Optional) | | | | |

MVP Versa, Versa Duo and Versa Pro - SPI and SMT inspection.

The Versa systems deploy the highest speed interfaces, computers, optics and 3D technologies to provide the fastest inspection times without compromising defect detection.

MVP's Flying Stage combined with Quad-Color and 3D technology and allows faster inspection cycle times while increasing inspection capabilities. Additionally, with enhanced defect coverage, false rejects are minimized.

The Versa series of AOI solutions complements MVP's wide range of award winning AOI products and allow for the introduction of versatile and flexible solutions with the capability to increase performance and speed metrics at the same time.

- MVP's Fastest AOI Platform
- Flexible, Reliable and Robust Hardware
- 3D Profilers and Projectors
- Combined 2D & 3D optics packages
- SPI, SMT & Hybrid Inspection
- Easy-To-Use Performance Based Programming
- 01005 Solder Joint Inspection

¹ Using standard resolution, quarter range. Scan speed can be increased using larger profile steps.

MVP and the MVP logo are trademarks of Machine Vision Products, Inc. All other brand and product names are trademarks or registered © Machine Vision Products, Inc., 2024, All rights reserved.

VSA-43024 + 62124-1



Worldwide Headquarters Vista, California, USA. +1 (760) 438-1138 sales@visionpro.com European Headquarters Fife, Scotland, UK. +44 (0) 1383 842861 saleseurope@visionpro.com Asia-Pacific Headquarters, Xuhui, Shanghai, PR China 200232 salesasia@visionpro.com

² Dependent on camera and lens configurations.

 $^{^{3}}$ Please check final chosen configuration, some options can reduce board size.

 $^{^4}$ Flex Circuits, Non-Rigid boards will require fixturing. 12.5mm is an advisory for board thickness.

⁵ Static repeatability using MVP calibration target.

⁶ Base Versa System

⁷ Program Dependant